



## P-Channel Enhancement-Mode Vertical DMOS FETs

### Ordering Information

BV <sub>DSS</sub> / BV <sub>DGS</sub>	R <sub>DS(ON)</sub> (max)	I <sub>D(ON)</sub> (min)	Order Number / Package		
			TO-92	TO-236AB*	Die†
-60V	12Ω	-0.5A	VP2106N3	—	—
-100V	12Ω	-0.5A	—	VP2110K1	VP2110ND

Product marking for SOT-23: P1A* where * = 2-week alpha date code
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† MIL visual screening available.

\* Same as SOT-23. All units shipped on 3,000 piece carrier tape reels.

### Features

- Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C<sub>iss</sub> and fast switching speeds
- Excellent thermal stability
- Integral Source-Drain diode
- High input impedance and high gain
- Complementary N- and P-channel devices

### Applications

- Motor controls
- Converters
- Amplifiers
- Switches
- Power supply circuits
- Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

### Absolute Maximum Ratings

Drain-to-Source Voltage	BV <sub>DSS</sub>
Drain-to-Gate Voltage	BV <sub>DGS</sub>
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

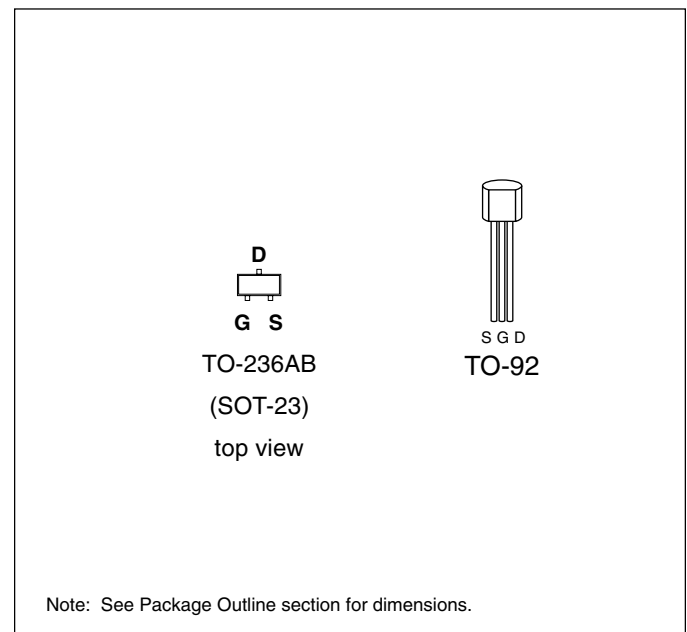
\* Distance of 1.6 mm from case for 10 seconds.

### Advanced DMOS Technology

These enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

### Package Options



## Thermal Characteristics

Package	$I_D$ (continuous)*	$I_D$ (pulsed)	Power Dissipation @ $T_A = 25^\circ\text{C}$	$\theta_{jc}$ $^\circ\text{C/W}$	$\theta_{ja}$ $^\circ\text{C/W}$	$I_{DR}^*$	$I_{DRM}$
TO-236AB	-120mA	-400mA	0.36W	200	350	-120mA	-400mA
TO-92	-0.25A	-0.8A	0.74W	125	170	-0.25A	-0.8A

\*  $I_D$  (continuous) is limited by max rated  $T_j$ .

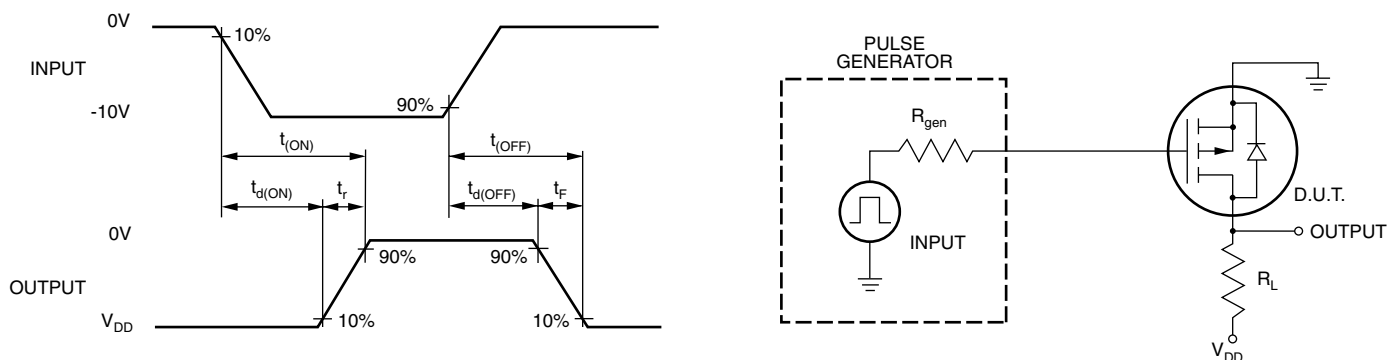
## Electrical Characteristics (@ $25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
$BV_{DSS}$	Drain-to-Source Breakdown Voltage	VP2110	-100		V	$I_D = -1.0\text{mA}$ , $V_{GS} = 0\text{V}$
		VP2106	-60			
$V_{GS(th)}$	Gate Threshold Voltage	-1.5		-3.5	V	$V_{GS} = V_{DS}$ , $I_D = -1.0\text{mA}$
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with Temperature		5.8	6.5	mV/ $^\circ\text{C}$	$I_D = -1.0\text{mA}$ , $V_{GS} = V_{DS}$
$I_{GSS}$	Gate Body Leakage		-1.0	-100	nA	$V_{GS} = \pm 20\text{V}$ , $V_{DS} = 0\text{V}$
$I_{DSS}$	Zero Gate Voltage Drain Current			-10	$\mu\text{A}$	$V_{GS} = 0\text{V}$ , $V_{DS} = \text{Max Rating}$
				-1	mA	$V_{GS} = 0\text{V}$ , $V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}$
$I_{D(ON)}$	ON-State Drain Current	-0.50	-1.0		A	$V_{GS} = -10\text{V}$ , $V_{DS} = -25\text{V}$
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance		11	15	$\Omega$	$V_{GS} = -5\text{V}$ , $I_D = -0.1\text{A}$
			9.0	12		$V_{GS} = -10\text{V}$ , $I_D = -0.5\text{A}$
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with Temperature		0.55	1.0	%/ $^\circ\text{C}$	$V_{GS} = -10\text{V}$ , $I_D = -0.5\text{A}$
$G_{FS}$	Forward Transconductance	150	200		m $\Omega$	$V_{DS} = -25\text{V}$ , $I_D = -0.5\text{A}$
$C_{ISS}$	Input Capacitance		45	60	pF	$V_{GS} = 0\text{V}$ , $V_{DS} = -25\text{V}$ $f = 1 \text{ MHz}$
$C_{OSS}$	Common Source Output Capacitance		22	30		
$C_{RSS}$	Reverse Transfer Capacitance		3	8		
$t_{d(ON)}$	Turn-ON Delay Time		4	5	ns	$V_{DD} = -25\text{V}$ $I_D = -0.5\text{A}$ $R_{GEN} = 25\Omega$
$t_r$	Rise Time		5	8		
$t_{d(OFF)}$	Turn-OFF Delay Time		5	9		
$t_f$	Fall Time		4	8		
$V_{SD}$	Diode Forward Voltage Drop		-1.2	-2.0	V	$I_{SD} = -0.5\text{A}$ , $V_{GS} = 0\text{V}$
$t_{rr}$	Reverse Recovery Time		400		ns	$I_{SD} = -0.5\text{A}$ , $V_{GS} = 0\text{V}$

### Notes:

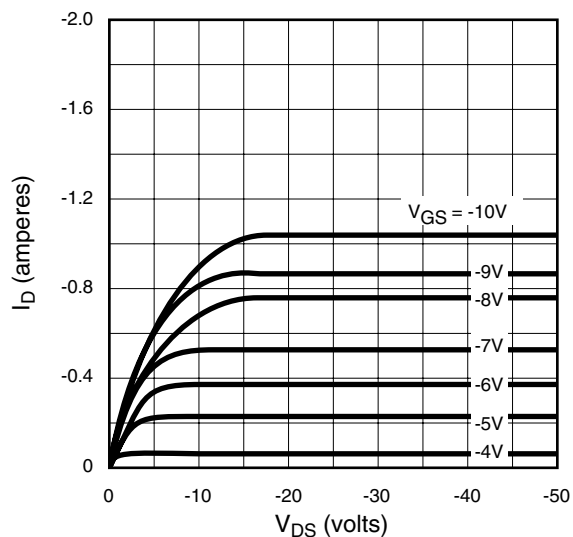
- All D.C. parameters 100% tested at  $25^\circ\text{C}$  unless otherwise stated. (Pulse test: 300 $\mu\text{s}$  pulse, 2% duty cycle.)
- All A.C. parameters sample tested.

## Switching Waveforms and Test Circuit

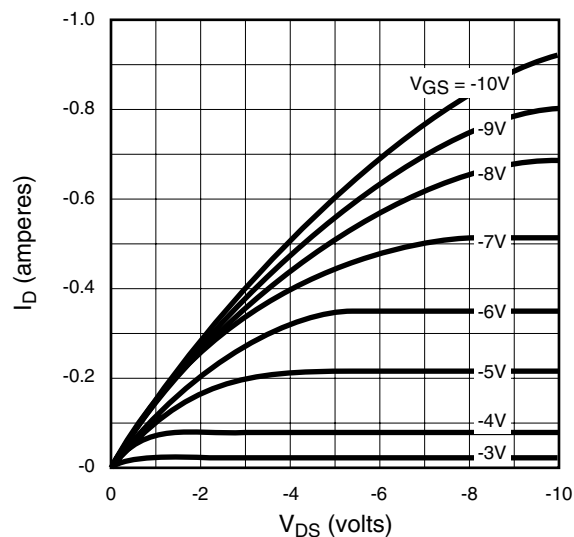


# Typical Performance Curves

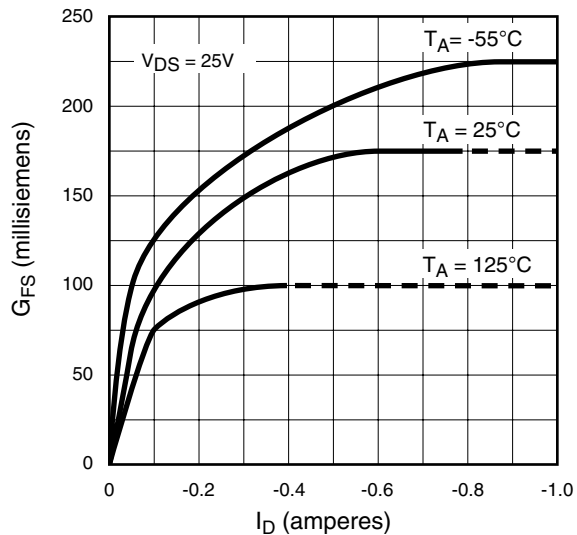
Output Characteristics



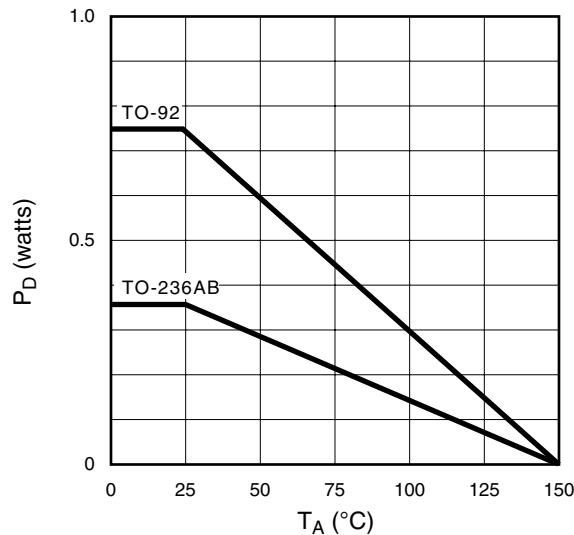
Saturation Characteristics



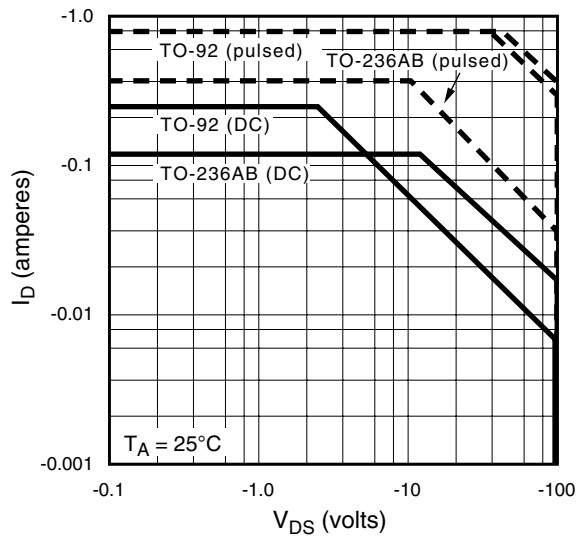
Transconductance vs. Drain Current



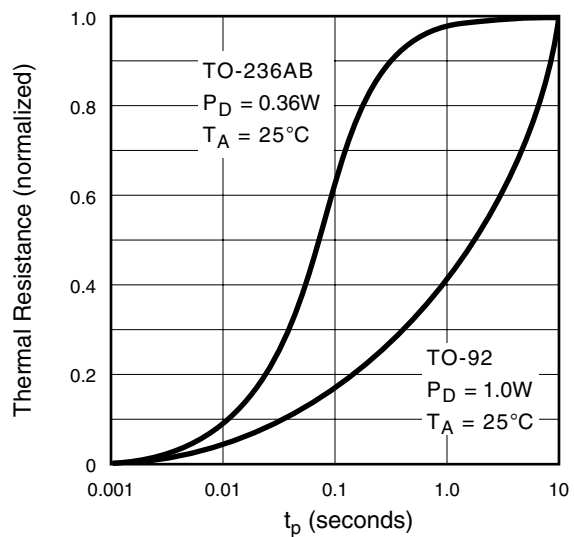
Power Dissipation vs. Ambient Temperature



Maximum Rated Safe Operating Area



Thermal Response Characteristics



# Typical Performance Curves

